ASSIGNMENT

W	HEKEAS, I/WE (1) <u>1 ai</u>	kuma hojo,
a Ja	pan	citizen, residing at Kawasaki-shi, Japan
(2) Kiyosh	i ISHIKAWA	
		citizen, residing at Kawasaki-shi, Japan
(3)Tsuyosh	ni NAKAMURA	
		citizen, residing at Kawasaki-shi, Japan
	MATSUMIYA	•
		citizen, residing at Kawasaki-shi, Japan
new and	useful improvements on of which:	r (collectively if more than one inventor is listed above), have invented certain in POSITIVE PHOTORESIST COMPOSITION AND METHOD FOR the FORMING RESIST PATTERN even date herewith;
(b) [☐ Express Mai	as Application No. 0 / or all No., as Application No. not yet known and was (if applicable); or
(c) 🗵		d claimed in PCT International Application No. <u>PCT/JP2004/005804</u> filed 2. 2004 and as amended under PCT Article 19 on (if any) and/or under PCT Article 34 on

AND WHEREAS, TOKYO OHKA KOGYO CO., LTD.; with its principal place of business at 150, Nakamaruko, nakahara-ku, Kawasaki-shi, Kanagawa-ken, Japan; (hereinafter referred to as Assignee) desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignor hereby acknowledges that it has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto Assignee, its successors, legal representatives and assigns, the entire right, title, and interest in the United States of America, and its territories and possessions in, to and under said improvements, and any Patent Applications in the United States of America and all divisions, renewals and continuations thereof, and all Patents of the United States of America which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions; and Assignor hereby authorizes and requests the Commissioner of Patents of the United States of America to issue all Patents for said improvements to Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR HEREBY covenants and agrees that it will communicate to Assignee, its successors, legal representatives and assigns, any facts known to it respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in the United States of America.

COPY DO NOT RECORD IN TESTIMONY WHEREOF, Assignor intending to be legally bound has hereunto affixed its signature.

This 15th day of May , 200 6	Takuma HOJO Signature of Takuma HOJO
This 15th day of May , 200 6	Kuyoshi Oshihawa Signature of Kiyoshi ISHIKAWA
This 15th day of May , 200 6	Signature of Tsuyoshi NAKAMURA
This, 200_6	Tasuku Matsumiya Signature of Tasuku MATSUMIYA

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Witnessed by:

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